# MN101E59 Series

| Туре                                  | MN101E59R  | MN101EF59R |
|---------------------------------------|--|------------|
| Internal ROM type                     | Mask ROM   | FLASH      |
| ROM (byte)                            | 928K   |            |
| RAM (byte)                            | 8K   |            |
| Package (Lead-free)                   | QFP100-P-1818B   |            |
| Minimum Instruction<br>Execution Time | 50 ns (at 2.2 V to 5.5 V, 20 MHz) *: at internal 2, 3, 4, 5, 6, 8, 10 times oscillation used |            |

#### ■ Interrupts

6 external interrupts. 30 internal interrupts

RESET. NMI. External 0 to 4. Timer 0 to 4. Timer 6. Timer 7 (2 systems). Timer 8 (2 systems). Timer 9 (2 systems). Time base. Serial 0 (2 systems). Serial 1 (2 systems). Serial 2 (2 systems). Serial 3 (2 systems). Serial 4. Serial 5. A/D conversion. Automatic transfer (2 systems). Key interrupt. End of single tone. End of phrase

#### ■ Timer Counter

8-bit timer × 7

| Timer 0Timer pulse output. Event count. Added pulse (2-bit) type PWM output. Remote control carrier output. Simple  | :    |
|---|------|
| pulse width measurement. Real time output control   |      |
| Timer 1Timer pulse output. Event count. 16-bit cascade connected (timer 0, 1). Timer synchronous output   |      |
| Timer 2Timer pulse output. Event count. Added pulse (2-bit) type PWM output. Simple pulse width measurement. 24-cascade connected (timer 0, 1, 2). Timer synchronous output. Real time output control                     | bit  |
|   |      |
| Timer 3Timer pulse output. Event count. Remote control carrier output. 16-bit cascade connected (timer 2, 3). 32-bit cascade connected (timer 0, 1, 2, 3)   |      |
| Timer 4Timer pulse output. Added pulse (2-bit) type PWM output. Event count. Serial transfer clock output. Simple pulse output.   | ılse |
| width measurement   |      |
| Timer 68-bit freerun timer. Time base timer   |      |
| Timer AEvent count. Baud rate timer. Clock output for peripheral function   |      |
| 16-bit timer $\times$ 3   |      |
| Timer 7Timer pulse output. Event count. High accuracy PWM. High performance IGBT output (cycle/duty continuous  | 3    |
| variable). Timer synchronous output. Input capture (both edge available). Real time output control. Double but compare register   | fer  |
| Timer 8Timer pulse output. Event count. High accuracy PWM output (cycle/duty continuous variable). Pulse width  |      |
| measurement. Input capture (both edge available). 32-bit cascade connected (timer 7, 8). 32-bit PWM output.   |      |
| Synchronous output event. Double buffer compare register  |      |
| Timer 9Timer pulse output. Event count. High accuracy PWM output (cycle/duty continuous variable). Pulse width measurement. Input capture (both edge available). Real time output control. Double buffer compare register |      |
| incustrement. Input cupture (both cuge uvariable). Real time output control. Double outlet compare register   |      |

Watchdog timer × 1

# ■ Serial interface

Synchronous type/UART (full-duplex)  $\times$  4: Serial 0 to 3 Synchronous type/Multi-master  $I^2C \times 1$ : Serial 4

 $I^2C$  slave  $\times$  1: Serial 5

## ■ DMA controller

2 systems. Maximum transfer cycles are 255 Starting factor: External request. Internal event. Software

#### ■ I/O Pins

I/O 85: Common use. Specified pull-up/pull-down resistor available. Input/output selectable (bit unit)

#### ■ A/D converter

10-bit × 12 channels

# ■ D/A converter

8-bit × 4 channels. 20-bit × 2 channels. (Sound reproduction: digital output, analog output)

Panasonic MAD00078BEM

# ■ Display control function

LCD: 55 segments  $\times$  4 commons (Static, 1/2, 1/3, or 1/4 duty) 1/3 bias Usable if VLC1  $\leq$  VDD

# ■ Special Ports

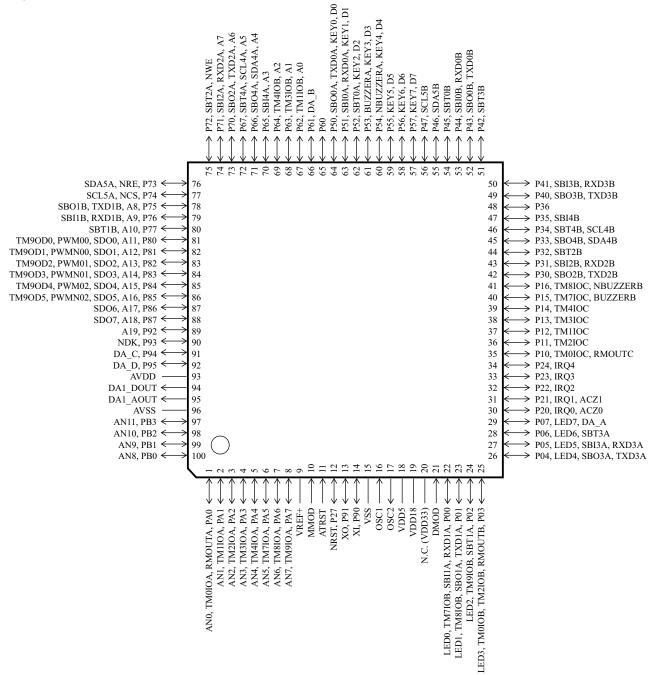
Buzzer output. Inverted buzzer output. Remote control carrier output. High-current drive port

#### ■ ROM Correction

Correcting address designation: Up to 7 addresses possible

# ■ Pin Assignment

QFP100-P-1818B



Note) (): Flash memory built-in type

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